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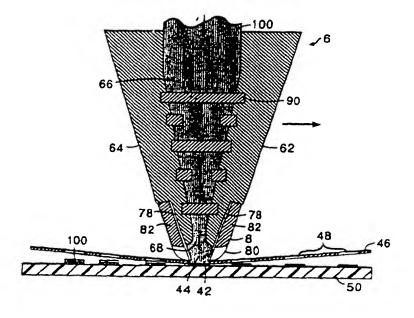
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(54) Title: METHOD AND APPARATUS FOR DISPENSING VISCOUS MATERIAL



(57) Abstract

An apparatus for compressing viscous material through openings in a stencil is disclosed. The apparatus has a compression headcap (8) which provides a contained environment to direct and to aid the flow of pressurised viscous material through the openings (48) in the stencil. The compression headcap (8) includes two generally parallel wiper blades (78) that are in sliding communication with the stencil (46). Longitudinal diffuser plates (90) guide and equalise the flow of the viscous material into the volume between two generally parallel wiper blades (78).

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METHOD AND APPARATUS FOR DISPENSING VISCOUS MATERIAL

Field of the Invention

The present invention relates to methods and devices for depositing viscous materials onto a printed wiring board and to methods and devices for compressing viscous materials, such as solder paste, through openings in a perforated substrate, such as a patterned screen or stencil.

Description of Related Art

Surface Mount Technology (SMT) involves placing circuit components onto circuit paths embedded on the upper surface of a printed wiring board and then soldering the components in place by a process called "reflow soldering". Before the circuit component is placed on the printed wiring board, however, it is desirable to apply solder paste to the area on the printed wiring board where the component is to be soldered into place.

Conventional methods do exist to deposit ("print") solder paste onto desired areas of a printed wiring board by forcing the paste through openings in a substrate (e.g., a stencil) placed in intimate contact with the printed wiring board.

U.S. Patent No. 4,622,239 describes such a method and device for dispensing viscous materials. The method includes forcing a viscous material from a housing through an opening and depositing it onto a stencil between a pair of flexible members (parallel squeegee blades) which depend from the housing on either side of the opening and are in contact with the stencil. The ends of the flexible members are not connected and remain open ended. The viscous material, accordingly, is not contained within an enclosed area when it is deposited on the surface of the stencil. Movement of the housing and the flexible members horizontally across the

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stencil causes the trailing flexible member to force the viscous material through the openings in the stencil.

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U.S. Patent No. 4,720,402 describes a similar method and device except that the leading flexible member is raised off of the stencil during movement of the housing.

U.S. Patent Nos. 5,133,120 and 5,191,709 describe methods for filling through-holes of a printed wiring board via a mask with pressurised conductive filler material by means of a nozzle assembly unit having a nozzle tip member. The nozzle tip member, however, is designed only to dispense the pressurised conductive filler material through the mask to a single through-hole. The nozzle tip member then "scans" the printed wiring board for a second through-hole to fill. The nozzle tip member has a blunt end section which rests on the mask and a circular exit, the diameter of which may be increased or decreased by changing the nozzle tip member. The nozzle tip member dispenses the filler material without controlling unwanted flow of "excessive" filler material back through the stencil. Additionally, the nozzle tip member does not define a contained environment where "compression" of the filler material takes place through the mask followed by the immediate shearing off of the filler material within that contained environment from the surface of the stencil. In fact, the nozzle tip member itself provides no effective means for shearing off filler material from the top of the stencil, rather, after the through hole is filled and filler material "backs up" through the stencil, the nozzle tip member moves forward whereupon the "excessive" filler material is then wiped off by a separate, single, flexible squeegee member which is designed for unidirectional use only.

Unfortunately, these conventional efforts do not provide a contained environment for compression of viscous material through holes in a stencil and shearing of viscous material within the contained environment from the upper surface of the stencil. Reliance upon squeegee movement to force the viscous material, such as solder paste, through the stencil

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openings can lead to damage and eventual failure of both the squeegee blades and the stencil due to repeated friction. Since conventional efforts do not provide a contained environment in which compression and shearing is accomplished, waste of the viscous material is frequently encountered.

The above prior art proposals therefore fail to maximise the efficiency of printing solder paste onto a desired area of a printed wiring board and fail to minimise waste of the solder paste during the printing process.

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U.S. Patent 5,345,867 describes generally parallel, offset "doctor blades" for stripping off ink from the ink roller of a web-fed rotary printing press. The doctor blades 9,8 are each biased into the ink roller 2 by suitable springs 54,53 that are contained within channels 49,48, respectively. These springs function to "resiliently urge the outer ends of the blades 9 and 8 into engagement with the screened ink roller 2 at a negative contact angle" in order to assure that the blades will not be deformed or bent and that proper contact with the ink roller will be maintained. However, these blades cannot be adapted for the application of a viscous material and would not function to relieve pressure as the printhead rides unevenly across the substrate.

The present invention is concerned with keeping the full length of the edge of the wiper or squeegee blades parallel with the stencil as the printhead travels at high speed, when the hydrodynamic pressure induced by the rolling action of the viscous material ahead of the leading edge wiper blade causes it to lift up from the surface of the stencil (much like the hydroplaning in an automobile tire tracking over a fluid covering the driving surface). Conventional solutions to this problem such as central pivot floatation of the wiper blades results in uneven pressures along the length of the wiper blades during printing, and thus uneven and possibly defective print transfer of the viscous material within the apertures in the stencil.

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Summary of the invention

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According to a first aspect of the invention, there is provided an apparatus for compressing a viscous material through openings in a stencil, comprising a reservoir containing a supply of the viscous material; a pressure source operably connected to the reservoir whereby pressure is applied to the supply of viscous material; a housing having a first opening in fluid communication with the reservoir and a substantially uniform second opening defined by a compression headcap formed from contiguous walls, the compression headcap having a pair of wiping blades, and

means for biasing said wiping blades into sliding communication over the stencil.

According to a second aspect of the invention, there is provided an apparatus for compressing reflow solder material through openings in a stencil, comprising a reservoir containing a supply of reflow solder material; a pressure source operably connected to the reservoir whereby pressure is applied to the supply of reflow solder material; a housing having a first opening in fluid communication with the reservoir and a substantially rectangular second opening defined by a compression headcap formed from two generally parallel wiper blades, said compression headcap defining a volume into which the pressurised reflow solder material flows from an interior chamber of the housing; and means for biasing each of said parallel wiper blades into sliding communication, along the entire length thereof, with the stencil.

According to a third aspect of the invention, there is provided A method for compressing a viscous material through openings in a stencil comprising, the steps of directing the viscous material into a housing terminating in a compression headcap formed from contiguous walls, the compression headcap having a pair of generally parallel wiper blades defining a volume and a uniform exit passageway therebetween; placing the compression headcap in contact with the stencil and the

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apertures therein; applying pressure against the viscous material sufficient to force it from the housing via the compression headcap and into the apertures in the stencil; and biasing the parallel wiper blades into sliding communication against the stencil for enhancing the wiping action thereof.

According to a fourth aspect of the invention, there is provided an apparatus for compressing a viscous material through openings in a stencil, comprising a reservoir containing a supply of the viscous material; a pressure source operably connected to the reservoir whereby pressure is applied to the supply of viscous material; a housing having a first opening in fluid communication with the reservoir and a substantially rectangular second opening defined by a compression headcap formed from two generally parallel wiper blades, the opposing ends of which are connected by end caps, said compression headcap defining a volume into which pressurised viscous material flows from an interior chamber of the housing; and wherein said housing further includes longitudinal diffuser channels fixedly disposed within the housing for guiding and equalising the pressure on the viscous material flowing between said first opening and said compression headcap.

According to a further aspect of the invention, there is provided an apparatus for compressing a viscous material through openings in a stencil comprising a reservoir containing a supply of the viscous material; a pressure source operably connected to the reservoir whereby pressure is applied to the supply of viscous material; and a housing having a first opening in fluid communication with the reservoir and a substantially uniform second opening defined by a compression head cap formed from contiguous walls, the compression head cap having a pair of substantially parallel blades.

Embodiments of the present invention include a process herein referred to as "compression printing" wherein pressure is applied to a viscous material within a contained

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environment defined by a compression headcap so as to compress it through openings in a stencil.

The apparatus of the preferred embodiment of the present invention includes a reservoir containing viscous material which is operably connected to a pressure source. reservoir is in fluid communication with a housing which terminates in an opening defined by a compression headcap formed from contiquous walls. During operation of the apparatus, two generally parallel wiper blades forming the compression headcap are biased into sliding communication with a stencil having a plurality of openings therein. The compression headcap and the stencil form a contained environment. The pressure source then applies pressure against the viscous material contained in the reservoir forcing it from the reservoir into the housing and to the compression headcap. The contiguous walls of the compression headcap act to contain and to direct flow of the pressurised viscous material to the top surface of the stencil and then through the openings in the stencil. The biasing force against the wiper blades keeps them in sliding communication with the stencil, even when downward pressure induced on the viscous material being sheared off by the leading edge of the wiper blade tends to lift the compression headcap up and away from the stencil.

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Brief description of the drawings

The invention will now be described further, by way of example, with reference to the accompanying drawings, in which:

Figure 1 is a perspective view of an apparatus of the present invention, partially exploded,

Figure 2 is a side cross-sectional view of a compression head, a compression headcap, a stencil and a printed wiring board showing movement of the solder paste through the compression head, the compression headcap and the openings of the stencil onto the printed wiring board,

Figure 3 is a bottom perspective view of the compression headcap, partially broken away,

Figure 4 is an exploded perspective view of the compression head showing components of the compression headcap and one embodiment of a diffuser,

Figure 5 is an exploded perspective view of the compression head showing components of the compression headcap and a second embodiment of a diffuser,

Figure 6 is a partially exploded perspective view of a second embodiment of the compression headcap that includes a pair of self-levelling squeegee blades,

Figure 7 is a front view of the compression head shown in Figure 6 illustrating the location of the leaf springs,

Figure 8 is a top perspective view of the self-levelling squeegee blades taken along section lines 8-8 in Figure 7,

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Figure 9 is a side cross-sectional view of a second embodiment of the compression head, the compression headcap, a stencil and a printed wiring board showing movement of the solder paste through the compression head, the compression headcap and the opening of the stencil onto the printed wiring board,

Figure 10 is a bottom perspective view of the second embodiment of the compression head illustrating the location of the leaf springs and the integral end caps attached to the self-levelling blades,

Figure 11 is a bottom perspective exploded view illustrating the integral, overlapping end caps attached to the ends of the self-level squeegee blades, and

Figure 12 is an exploded perspective view of the second embodiment of the compression head, including a third embodiment of the diffuser plates having a vertical channel orientation.

Detailed description of the preferred embodiments

The principles of the present invention may be applied with particular advantage to obtain an apparatus for

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compressing a viscous material through openings in a stencil, preferred embodiments of which may be seen at Figs. 1, 2, 3, 4, and 5 which are described more fully below.

Figure 1 is a partially exploded perspective view of one embodiment of an apparatus of the present invention. As can be generally seen at Figure 1, the apparatus has a pressure source 2 which is operably connected to a reservoir 4 containing a supply of a viscous material, a compression head 6 and a compression headcap 8.

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More particularly, Figure 1 shows a pressure source depicted as an air cylinder 2 having a piston (not shown) connected to a rod 10 contained in a cylinder housing 12. Pressure inlet 14 allows for the introduction of air pressure at the top of air cylinder 2 thereby displacing the piston causing piston rod 10 to move downward. The air cylinder 2 is mounted via base 16 to cylinder mount 18 which in turn is removably mounted to casing 20 via a twist socket connector having posts 22 and socket grooves, one of which is shown at 24. Base 16 has air inlet 26 for the introduction of air pressure at the bottom of air cylinder 2 thereby displacing the piston causing piston rod 10 to move upward.

Piston rod 10 extends through opening 28 of cylinder mount 18 and is fixedly connected to syringe pusher 30 at contact 32 which in turn engages displacement piece 34 which is movably disposed within syringe 4 which contains a viscous material. Displacement piece 34 acts as a plunger and is designed to mate with the interior of syringe 4 to ensure effective displacement of viscous material with minimal waste. Pressure source 2 is designed to mechanically meter out viscous material through operation of the syringe pusher 30 on the displacement piece 34. The syringe pusher 30, displacement piece 34 and syringe 4 are all vertically housed in operative fashion within the cylinder mount 18, the casing 20 and the syringe housing 36.

The vertical arrangement of the pressure source 2 and the syringe 4 containing the viscous material is a preferred arrangement which advantageously provides for even and direct

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pressure in metering out the viscous material onto the top surface of a stencil. It is to be understood that pressure source 2 is not limited to an air cylinder of the type depicted in Figure 1, but that other suitable pressure sources may be used by one of ordinary skill in the art. Such pressure sources include those which mechanically, electrically, or hydraulically operate a mechanical force, such as a piston rod and displacement piece, to meter out viscous material from a syringe housing or other reservoir which contains viscous material. In addition, pneumatic pressure may be used directly to force viscous material from a reservoir housing. Also, pressure source and reservoir configurations other than the vertical configuration depicted in Figure 1 may be used in the present invention. Such configurations include side mounted reservoirs and pressure sources or other configurations readily known to those skilled in the art.

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The syringe 4 is preferably a disposable unit which can be replaced when desired by disconnecting cylinder mount 18 from casing 20 via the twist socket connector, removing the syringe and replacing it with an alternative syringe. Examples of disposable syringes that may be used include those which are readily commercially available from Methods Engineering, Vauxhall, New Jersey. The cartridges may be purchased prefilled with suitable viscous materials or they may be purchased empty and then filled with suitable viscous materials, such as solder pastes. Suitable solder pastes may be readily commercially available from Alpha Metals, Jersey City, New Jersey.

Typical solder pastes useful with surface mount technology generally contain an alloy of tin, lead and silver in various proportions in combination with other useful solder paste metals, viscosity agents, flux and/or solvents depending upon the desired use of the solder paste. Suitable solder pastes will become apparent to one of ordinary skill in the art based upon the teachings herein.

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The syringe housing 36 is mounted to a housing referred to herein as a compression head generally depicted at 6 in Figure 1 and shown in a cross-sectional side view in Figure The syringe 4 has flange opening 38 which is inserted into and mates with first opening 40 of compression head 6 which is described hereafter with reference to both Figs. 1 and 2 and Figure 3 which is a bottom perspective view of the compression headcap 8, partially broken away. compression head 6 terminates in a substantially uniform second opening 42 which is defined by compression headcap 8. The compression headcap 8 is formed from contiguous walls which define a volume 44 within compression headcap 8. contiguous walls may be either unitary or formed from separate elements and are designed to contact stencil 46 to provide a uniform and substantially flush union with stencil 46 at the point of contact. As can be seen in Figure 2, stencil 46 has openings 48 and is placed in an operable relationship with a printed wiring board 50. The stencil 46 may be placed in intimate contact with printed wiring board 50 or, as shown in Figure 2, it may be placed a distance above printed wiring board 50 such that pressure from the compression head 6 forces the stencil 46 into contact with printed wiring board 50. Although stencil 46 is shown in cross-section, it is to be understood that openings 48 may have any desired orientation on stencil 46. Further openings 48 may differ in size depending upon the area of the printed wiring board 50 to be printed with the viscous material. compression headcap 8 and stencil 46 together form a contained environment 44 for the viscous material during operation of the apparatus.

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As can be seen in Figure 1, cross bar mount 52 is attached to syringe housing 36 via flange 54. Cross bar mount 52 is also attached to a mechanism (not shown) for horizontally displacing the apparatus along the stencil 46.

The compression head 6 is preferably formed from metal, such as iron or stainless steel or other material suitable for use with pressurised viscous material. The compression

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head 6 has top surface 56 which serves as the base to which the syringe housing 36 is attached. Side surfaces 58 and 60 extending from top surface 56 slope away from each other as depicted in Figure 1 to define an increasing length of compression head 6. Front and back surfaces 62 and 64 are contiguous with side surfaces 58 and 60 and slope toward each other as depicted in Figure 2 to define a decreasing width of compression head 6. The side surfaces join with the front and back surfaces to define a tapered interior chamber 66 as shown in Figure 2 which acts to restrict flow of viscous material through compression head 6. Interior chamber 66 terminates in generally rectangular exit 68. Compression head 6 preferably acts as a nozzle to direct and constrict the flow of viscous material through generally rectangular exit 68. The compression headcap 6 defines a volume 44 surrounding the rectangular exit 68 and into which viscous material flows after exiting the interior chamber 66 of compression head 6. As shown in Figure 2, the volume 44 is preferably a separate chamber into which the viscous material flows after exiting the interior chamber 66 via rectangular exit 68. The compression headcap 8 defines a generally rectangular opening 42 which is to be contacted with stencil The compression headcap 8 acts to contain and direct the flow of viscous material to the stencil 46. alternative embodiment, it is to be understood that the interior chamber 66 may terminate directly into compression headcap 8 without the need for rectangular exit 68 or volume 44.

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As can be seen in Figure 4, the compression head 6 has
two half sections 70 which are fixedly connected by screws
(not shown) via screw holes 72. The bottom side section 74
of each half section 70 is provided with ledge area 76 to
engage the compression headcap 8. As depicted in Figs. 2, 3
and 4, compression headcap 8 has rectangular blades 78 and
end caps 80, which define generally rectangular opening 42.
Blades 78 are each fixedly mounted to a corresponding ledge
area 76 of front surface 62 and back surface 64,

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respectively, by means of corresponding rectangular blade holders 82 and screws (not shown) via screw holes 84. Blades 78 each extend along substantially the entire length of corresponding ledge area 76. End caps 80 are attached to a corresponding ledge area 76 of bottom side section 74 via corresponding cap mounts 86 and screws (not shown) via screw holes 88. The end caps 80 are contiguous with blades 78 and together form the compression headcap 8. As can be seen more clearly in Figure 2, blades 78 parallel the slope of corresponding front and back surfaces 62 and 64, and are, therefore, seen to be angled inward relative to the interior chamber 66 of compression head 8.

Blades 78 are preferably thin and formed from rigid material such as iron or stainless steel. End caps 80 are preferably formed from a flexible substance such as polyurethane to avoid damage to the stencil during operation of the apparatus. Cap mounts 86 and blade holders 82 are formed from any solid material capable of securing the corresponding end cap or blade.

While the compression headcap 8 is depicted in Figs. 2, 3, and 4 as being formed from integral parts, it is to be understood that compression headcaps having a unitary structure are within the teachings of the present invention. Such unitary compression headcaps are formed from a single rectangular shaped unit and are designed to encircle the ledge area 76 of the compression head 6 or otherwise operatively engage compression head 6. Such compression headcaps may be either fixed or removably mounted to the compression head and may have various sizes of opening 42.

The compression head 6 and compression headcap 8, in combination with the pressure source 2 and syringe 4 advantageously provide a vertical down force to move the viscous material evenly and directly to the stencil. The compression headcap 8 of advantageously provides a contained environment to direct and to aid in the extruding of pressurised viscous material through openings in the stencil. The extruded viscous material is then deposited on the

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pattern of the printed wiring board. The apparatus provides for very high speed printing capability while maintaining print definition and reduced cycle time. Waste of viscous material is minimised due to the contained environment provided by the compression headcap 8. The length of the compression headcap 8 allows for simultaneous compression printing through a plurality of openings 48 in stencil 46. Furthermore, the trailing blade 78 relative to the direction of operation advantageously operates to shear off the viscous material contacting the stencil within the compression headcap 8 when the apparatus is horizontally disposed across the stencil. The blades 78 are rigid and angled to advantageously achieve a smooth shearing of the viscous material. The compression head 6 and compression headcap 8 are advantageously rectangular in shape so that they may operate over a significant area of the stencil with each pass. Additionally, given the dual blade design of the compression headcap 8, the apparatus may operate in both the forward and reverse directions thereby improving the efficiency of the compression printing process.

As can be further seen in Figs. 2 and 4, compression head 6 has diffuser 90 which is fixedly mounted within interior chamber 66. Diffuser 90 has a plurality of diffuser plates 92 which are horizontally disposed within interior chamber 66 via grooves 94. Each diffuser plate 92 has a series of openings 96 through which viscous material is to flow. Each opening 96 may be either circular or oblong and decreases in average size as the diffuser plates progress from the first opening 40 to the compression headcap 8. The openings 96 also increase in number as the diffuser plates progress from the first opening 40 to the compression headcap The diffuser 90 advantageously serves to break up the flow of viscous material and evenly and uniformly distribute it from side to side of the rectangular exit 42. diffuser 90 may also serve to reduce the velocity of the viscous material flowing through the compression head and

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increase the static pressure of the viscous material which aids in the compression printing process.

Figure 5 shows an alternative embodiment of a diffuser 90 that may be used. The diffuser 90 has a plurality of diffuser islands 98 which are horizontally disposed in rows within interior chamber 66. The diffuser islands 98 may be fixedly installed within the interior chamber 66 or they may be moulded directly within the interior chamber 66. As with the diffuser 90 of Figure 4, each diffuser island 98 acts to break up the flow of the viscous material and uniformly and evenly distribute it from side to side of rectangular exit The diffuser islands may be either circular or oblong and decrease in average size as the rows progress from the first opening 40 to the compression headcap 8. The diffuser islands 98 also increase in number as the rows progress from the first opening 40 to the compression headcap 8. diffuser islands 98 are advantageous in that they provide for ease of fabrication of the compression head and ease of cleaning.

Operation of the apparatus will now described with reference to Figs. 1 and 2. When compression printing, the compression headcap 8 of the apparatus is brought into contact with the top surface of stencil 46 which forces the stencil downward until it is in intimate contact with the printed wiring board below as shown in Figure 2. The apparatus is then moved in a horizontal direction, as shown in Figure 2, across the stencil 46.

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During movement of the stencil, pressure source 2 acts on syringe 4 to force viscous material 100 from the syringe 4 into the interior chamber 66 of compression head 6 where it is diffused by diffuser 90 and directed to rectangular exit 68. The viscous material then enters volume 44 of compression headcap 8 which provides a contained environment via blades 78 and end caps 80 to direct the pressurised viscous material under pressure to the top surface of stencil 46. The viscous material is then extruded through openings 48 in the stencil 46 over which the compression headcap 8

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travels. The extruded viscous material 100 is thereby printed on the printed wiring board 50. Movement of the compression headcap 8 across the stencil surface causes the trailing blade 78 which is angled inwardly relative to the interior chamber 66 to shear off the viscous material from the top surface of stencil 46. Once the apparatus has traversed the length of the stencil, the apparatus may simply reverse its direction and continue the compression printing process since the compression headcap 8 has dual blades 78 to accomplish the shearing process in either direction of movement.

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Operating variables of the apparatus, such as run speed and pressure, may be adjusted to accommodate either viscous materials having a wide range of viscosities or stencils with holes having a wide range of diameters. The following data in Table 1 is representative of the parameters at which the apparatus has successfully operated. Print speed is measures in inches per second, air pressure is measured in pounds per square inch, viscosity of the solder paste is measured in centipoises per second, stencil apertures are measured in inches, and the particle sizes of the solder pastes used are between 10-37 microns.

TABLE 1

25 Print Speed Air Pressure Viscosity Aperture (inches/sec.) (inches) (psi) (cps) Low High High Low High Low 1.0M 0.0055 >0.025 30 0.94 1.26 20 850K 1.45 1.70 1.0M 0.0055 >0.025 20 850K >0.025 0.0055 2.27 2.31 20 850K 1.0M >0.025 3.10 3.89 30 850K 1.0M 0.0055 >0.025 4.20 4.77 30 850k 1.0M 0.0055 35 5.98 6.62 0.0075 >0.025 40-50 850K 1.0M 6.69 7.23 0.0075 >0.025 50-60 850K 1.0M 7.70 8.00 50-60 0.0075 >0.025 850K 1.0M

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As indicated by the above data, the apparatus successfully operated over a wide range of print speeds, air pressures and stencil openings. The compression printing method disclosed herein advantageously provides for quicker print speeds, better quality of printing, and less waste of solder paste material than is encountered with conventional printing methods. A maximum print speed of 8 inches per second was achievable. It is noted, however, that for print speed in excess of 4.77 inches per second, increased air pressure was required in order to maintain acceptable print quality. This increased use of pressure produces two undesirable effects which was resolved in the second embodiment. These effects were: 1) Increases in pressure for improved print speeds caused an excessive back pressure 15 to be imparted on the squeegee head. This back pressure lifted the non-compliant blades of the first embodiment above the surface of the stencil resulting in paste being left on the stencil. Excess pressures (above 60 psi) further lifted the head due to back pressure such that poor print depositions occurred. In essence, the process window for the first embodiment was significantly more narrow than that of the second embodiment. 2) Excessive pressures may exceed the tension force of the stencil. If this occurs, deformation of the stencil may result making it unusable. For this reason, the lowest air pressure is desirable.

Second embodiment of the compression head

A second embodiment of the compression headcap will now be described with reference to Figures 6-11. Specific parts in the new compression headcap have been redesigned in order to provide higher through-put operation, more consistent coatings and reduced waste from the solder paste deposition process.

Except as specified hereafter, the second preferred embodiment of the compression head 106 includes the same

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parts as the original design for compression head 6. Parts having similar function will be defined by the same reference numerals as previously used in Figures 1-5, except that the new compression headcap design will have the reference numerals incremented by 100. As shown n Figures 6 and 9, the new compression head 106 contains corresponding elements such as the top surface 156, the side surfaces 158 and 160, the front and back surfaces 162 and 164 (hidden), and a tapered interior chamber 166 that terminates in a generally rectangular exit 168. The rectangular exit 168 opens into a tip volume 144 that is defined generally by the rectangular blades 178 on the sides, and the rectangular opening 142 at the bottom. As will be apparent from the subsequent explanation, the size of the rectangular opening 142 will vary depending upon the vertical displacement of the rectangular blades 178 as they ride across the stencil 46.

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In order for the solder paste 100 to be uniformly deposited in the apertures 48 within the stencil 46 and onto the substrate 50 at a high speed, it is necessary for the rectangular wiper or squeegee blades 178 to maintain uniform spacing from the upper surface of the stencil 46 under all conditions. Experimental tests have shown that irregularities in the planar surface of the stencil 46, bending moments, slight irregularities in the substrate 50 and excessive back pressure of the solder paste 100 against the stencil 46 can cause gaps between the distended ends of the rectangular wiper blades 178 and the stencil 46 periodically during the process.

The effect produced by excessive back pressure of the solder paste 100 against the stencil 46 occurs at high speeds where the pressure of the pusher 34 within the syringe 4 must be increased to inject sufficient solder paste 100 so as to fill the apertures 48 within the stencil 46. When this pressure exerted on the solder paste 100 exceeds the pressure of the printhead and the rectangular squeegee blades 178 downwardly onto the stencil 46, then the resulting back pressure tends to lift the entire compression head 106 away

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from the stencil 46. Downward pressure on the compression head 106 cannot be increased further because this pressure may stretch the stencil 46 which may be permanently deformed. This lifting of the compression head 106 also can cause leakage of the solder paste 100 and loss of contact between the rectangular squeegee blades and the stencil.

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The second preferred embodiment of the compression head 106 addresses this operational problem by providing a series of leaf springs 179a, b, c, and d which are more clearly illustrated in Figures 6, 7 and 9. With specific reference to Figure 6, the leaf spring 179a is contained within a channel formed by a first half 174a in the bottom side section 174 of the compression head 106 and another similar channel 182a in the rectangular blade holder 182. As illustrated in Figures 6 and 9, the upper edge of the rectangular blade 178 rests upon and compresses the four leaf springs 179a, b, c and d. The compression force serves to bias the rectangular wiper blade 178 into close communication with the stencil 46. In this manner, if a portion of the stencil is not flat or in some other manner is deformed, the biasing force produced by the leaf springs 179a, b, c and d will cause the distended edge of the rectangular wiper blades 178 to closely track the upper surface of the stencil 46, notwithstanding such surface defect. Furthermore, the downward pressure on the compression head 106 now may be increased to overcome the back pressure exerted by the solder paste 100 without damaging the stencil. The additional down pressure on the compression head 106 is compensated by the biasing forces of the springs 179 as they allow the compression head 106 to "float" over the stencil 46 without 30 losing contact as before. Thus, higher relative printing speeds may be maintained with improved quality levels, such as reduced bridging between adjacent but separated deposits of solder paste.

This close tracking of the upper surface of the stencil 46 by the distended end of the rectangular blade 178 allows the speed of the process to be increased substantially while

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at the same time improving the quality and consistency of the solder paste 100 deposited within the apertures 48 inside the stencil 46. For example, the conventional dual squeegee method for depositing the solder paste into apertures 48 within the stencil 46 operates at a linear speed of only about 2 inches per second, and in a production mode produces typical defects on the order of 480-485 parts per million. The compression head 6 illustrated in Figures 1, 2, 3 and 4 operates at a faster 3-4 inches per second, and yet products typical defects on the order of 95-100 parts per million. The improved compression head 106 as illustrated in Figures 6 through 11 is capable of operating at a linear speed of 6 inches per second (or greater), and yet produces typical defects on the order of only 11 parts per million. increase in speed and quality levels results, at least in part, from a reduction in pressure on the compression head 106 to less than 12 pounds (29 to 30 pounds per square inch for two blades over the maximum range of travel (0.090")) as compared to 25-30 pounds for the compression head 6 and more than 30 pounds pressure for prior art devices.

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When translated into throughput capabilities (as measured by test boards per hour, with zero bridging defects), the improved compression head 106 is capable of approximately 240 test boards per hour as compared to approximately 150 boards per hour for the compression head 6 and only about 90 boards per hour for the prior art flexible blade devices. The improvements in deposition uniformity (as defined by the standard deviation of the weight of solder deposited per area) is improved over the baseline provided by the flexible blade devices of the prior art by about 102% for the compression head 6 and by about 114% for the compression head 106. Estimated wasted solder paste per 300 gram syringe is reduced from approximately 75-100 grams for the flexible blade devices of the prior art, to approximately 50-75 grams for the compression head 6, and to only about 25 grams or less for the improved compression head 106.

These productivity and quality improvements are achieved even though the improved compression head 106 system is less expensive to manufacture because no complex equipment or processing is required to level the printhead prior to the printing process.

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While the preferred embodiment of the improved compression head 106 utilises leaf springs, it will be apparent that coiled springs or other similar mechanisms capable of providing a biasing force on the upper end of the rectangular blades 178 may also be used. While mechanical springs have been illustrated, the biasing force could also be exerted through hydraulic, pneumatic, hydrostatic or other similar means. The leaf springs 178 are manufactured from 0.010 inch thick spring steel that is approximately 0.1 inches to 0.25 inches in width. The shape and construction of the leaf springs 179a, b, c and d provide a biasing force of approximately 10 pounds to 12 pounds of pressure exerted upon the upper edge of the rectangular blade 178 for forcing the lower distended edge thereof into sliding communication with the stencil 46. For 0.040"-0.045" deflection (the normal operating range) to 0.090" (maximum deflection), the biasing force measured approximately 10.9 psi. The direction of the biasing force is generally parallel to the plane of the rectangular wiper blade 178 to force it into closer communication with the stencil 46. It will be apparent to one skilled in the art that these materials, measurements and pressures are listed as examples, and this embodiment could be easily adapt for enlarging the size of the compression head 106, increasing the speed of movement, etc.

It should be apparent from Figure 9 and the above description that as the rectangular wiper blades 178 cause a vertical movement and compression of the leaf springs 179a, b, c and d, the width of the rectangular opening 144 will vary. When both the leading and trailing rectangular wiper blades 178 are displaced in the vertical direction to compress the leaf springs 179, the rectangular opening 142 will increase slightly in width.

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As illustrated in Figures 8, 10 and 11, cooperating integral end caps 178a and 178b are located at the longitudinal ends of the rectangular blades 178 adjacent the end cap 180. The cooperating integral end caps 178a and 178b have vertically oriented sections that slidingly overlap each other as the width of the rectangular opening 142 changes. Therefore, the viscous material 100 will be held within the tip volume 144 by the overlapping surface produced by the cooperating integral end caps 178a and 178b, in cooperation with the end cap 180 and the end cap mounts 186.

The cooperating integral end caps 178a and 178b also include horizontally disposed pads that, while not overlapping, provide additional sealing impediments to the flow of the viscous material 100 from the ends of the rectangular opening 184. During operation, the cooperating integral end caps 178a and 178b substantially eliminate mounds of viscous material that can appear at the longitudinal ends of the compression head 106. By eliminating these wasteful mounds, the expensive viscous material can be conserved and additional cleaning steps for the substrates and the stencil are not required.

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Except for the above described mechanical changes in the second preferred embodiment of the compression head 106 and cap 108, the remainder of the method and apparatus for dispensing viscous material operates in according with the first preferred embodiment of the invention.

With reference to Figure 12, a third preferred embodiment of the compression head 206 is illustrated as including a plurality of diffuser plates 290 that are vertically disposed within the interior chamber 266. The plurality of diffuser plates 290 include two major diffuser plates 292 and four minor diffuser plates 294. Two subminor diffuser plates 296 are also included adjacent the lower portion of the interior chamber 266. These diffuser plates 290 serve to break up and redistribute the flow of the viscous material in order to evenly and uniformly present the material from side to side across the rectangular exit 242,

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while also serving to equalise the pressure of the viscous material flowing out of the rectangular opening 242.

The length, angular separation and relative separation between the plurality of diffuser plates 290 have been designed to provide the optimum balance between breaking up the flow of the viscous material and evenly distributing it throughout the entire cross section of the rectangular exit 242.

It should be apparent from Figure 12 that both the left section 260 and the right section 262 of the compression head 10 206 include a plurality of diffuser plates 290. In this embodiment, the major diffuser plates 292 in the visible left section 260 align precisely with corresponding major diffusion plates 292 in the hidden half of the right section 262 of the compression head 206. In a similar manner, the 15 minor diffusion plates 294 and the subminor diffusion plates 296 align with corresponding diffuser plates in the hidden right section 262 of the compression head 206. Under certain conditions it may be desirable to utilise diffuser plates of different lengths, different orientations and different 20 non-corresponding alignments in the two sections of the compression head 206 in order to provide additional mixing and to improve the uniformity of the viscous material as required by the specific application.

The vertical diffusion plates 290 are canted from the vertical direction by approximate angles of 6.5° for the first minor diffusion plate 294 closest to the centreline, 19.5° for the major diffusion plate 292, 33.5° for the second minor diffusion plate 294, and 44.5° for the subminor diffusion plate 296.

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The vertical channel design uses optimised streamwise vanes to guide the paste flow through the divergent compression printing head. The spread angles between diffuser plates 290 and the length of individual diffuser plates are analytically determined through computational fluid dynamics (CFD) technique so that the viscous material distributes evenly at the exit of the printing head.

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The new design results in a pressure drop reduction of about 21 pounds per square inch (from 91 to 70 pounds per square inch) to deliver the same volume of viscous material flow rate when compared with the previous design shown in Figures 1 through 5. Moreover, the undesired wakes behind the blockages of the old design are completely eliminated. This results in a uniform flow distribution at the head exit.

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The diffuser plates 290 equalise the velocity distribution of the viscous material at the exit and improve the pressure recovery. Since the divergent angle of the compression head is very large, it always gives rise to an undesired "stalled" condition in the diffuser. Instead of a uniform velocity distribution of the viscous material, the flow may form a jet-like pattern throughout the diffuser. The vertical channels subdivide the single large divergent passage into several smaller channels with much smaller opening angles to eliminate the flow stall. The velocity of the viscous material is always higher in the central region than that in the vicinity of the walls. It is essential that the geometrical configuration of the diffuser plates guide appropriate viscous material flow rates into each individual channel such that a uniform velocity distribution is attained at the exit. Consequently, channel width is relatively narrower near the centre and wider near the extremities. Moreover, for the passage away from the centreline, the divergent angle is not symmetric. This will create a biased Two subminor flow of the viscous material toward the centre. diffuser plates 296 are located near the exit of the two sidewall channels to correct this undesired effect. vertical channels defined by the diffuser plates 290 result in a reduction of the back pressure of about 24% on the flow of the viscous fluid 100 through the compression head 206.

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CLAIMS

1. An apparatus for compressing a viscous material through openings in a stencil, comprising:

a reservoir (4) containing a supply of the viscous material;

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a pressure source (2) operably connected to the reservoir (4) whereby pressure is applied to the supply of viscous material;

a housing (6) having a first opening in fluid communication with the reservoir (4) and a substantially uniform second opening defined by a compression headcap (8) formed from contiguous walls, the compression headcap (8) having a pair of substantially parallel wiping blades (78), and

means (179a-179d) for biasing said wiping blades (178) into sliding communication over the stencil.

- An apparatus as claimed in claim 1, wherein said
 contiguous walls comprise opposing faces of said pair of wiping blades linearly aligned substantially parallel to each other.
- 3. An apparatus as claimed in claim 1, wherein said second opening is formed from said pair of wiping blades (178) arranged to define a V-shaped opening of variable size.
- 4. An apparatus as claimed in claim 3 wherein the size of said second opening changes as said pair of wiping blades are displaced vertically against said biasing means.
 - 5. An apparatus as claimed in claim 3 wherein opposing ends of said parallel blades including juxtaposed integral caps for slidingly engaging each other to seal end sections of said second opening.

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- An apparatus as claimed in claim 1, wherein said biasing means comprise springs operatively interposed between said wiping blade and said housing.
- An apparatus as claimed in claim 6, wherein said 7. 5 springs comprise leaf springs.
- An apparatus as claimed in claim 6, wherein said springs exert a biasing force generally parallel to the plane of said wiping blade. 10
 - An apparatus as claimed in claim 1, wherein said housing is progressively tapered in width from said first opening to said compression headcap.
 - An apparatus for compressing reflow solder material through openings in a stencil, comprising:
 - a reservoir (4) containing a supply of reflow solder material:

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- a pressure source (2) operably connected to the 20 reservoir whereby pressure is applied to the supply of reflow solder material;
 - a housing (6) having a first opening in fluid communication with the reservoir (4) and a substantially rectangular second opening defined by a compression headcap (8) formed from two generally parallel wiper blades (178), said compression headcap defining a volume into which the pressurised reflow solder material flows from an interior chamber of the housing; and
 - means (179a 179d) for biasing each of said parallel wiper blades (178) into sliding communication, along the entire length thereof, with the stencil.
- An apparatus as claimed in claim 10 wherein said 11. biasing means comprise springs for exerting biasing forces 35 along the length of said wiper blades for levelling the

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sliding communication between said wiper blades and the stencil.

- 12. An apparatus as claimed in claim 11, wherein said biasing means comprises a plurality of leaf springs operatively coupled between said housing and said wiper blades.
- 13. An apparatus as claimed in claim 11 wherein said biasing means exerts a force on said wiper blades largely perpendicular to the plane of the stencil.
- 14. An apparatus as claimed in claim 10 wherein each of said wiper blades (178) include an integral end cap (180) for sliding sealing with a corresponding end cap of said wiper blade juxtaposed therewith.
- 15. An apparatus as claimed in claim 10 further including a plurality of longitudinal diffuser plates
 20 interposed between said first and second openings for channelling the flow and equalising the pressure of the reflow solder material therebetween.

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- 16. A method for compressing a viscous material through openings in a stencil comprising, the steps of,
 - (a) directing the viscous material into a housing terminating in a compression headcap formed from contiguous walls, the compression headcap having a pair of generally parallel wiper blades defining a volume and a uniform exit passageway therebetween;
 - (b) placing the compression headcap in contact with the stencil and the apertures therein; and
- (c) applying pressure against the viscous material sufficient to force it from the housing via the compression headcap and into the apertures in the stencil; and

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- (d) biasing the parallel wiper blades into sliding communication against the stencil for enhancing the wiping action thereof.
- 17. A method as claimed in claim 16, further comprising the step of imparting a relative motion between the housing and the stencil so as to cause the parallel wiper blades to shear viscous material from a top surface of the stencil.
- 10 18. A method as claimed in claim 17 wherein the stencil is in intimate contact with a printed wiring board for compressing the viscous material onto desired regions of the printed wiring board.
- 15 19. An apparatus for compressing a viscous material through openings in a stencil, comprising:

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a reservoir containing a supply of the viscous material;

a pressure source operably connected to the reservoir whereby pressure is applied to the supply of viscous material;

a housing having a first opening in fluid communication with the reservoir and a substantially rectangular second opening defined by a compression headcap formed from two generally parallel wiper blades, the opposing ends of which are connected by end caps, said compression headcap defining a volume into which pressurised viscous material flows from an interior chamber of the housing; and

wherein said housing further includes longitudinal diffuser channels fixedly disposed within the housing for guiding and equalising the pressure on the viscous material flowing between said first opening and said compression headcap.

20. An apparatus as claimed in claim 19 wherein said longitudinal diffuser channels are arranged generally in radial orientation between said first opening and a

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substantially layer said second opening for equalising the flow of the viscous material flowing therebetween.

- 21. An apparatus for compressing a viscous material through openings in a stencil comprising:
 - a reservoir containing a supply of the viscous material;

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- a pressure source operably connected to the reservoir whereby pressure is applied to the supply of viscous material; and
- a housing having a first opening in fluid communication with the reservoir and a substantially uniform second opening defined by a compression head cap formed from contiguous walls, the compression head cap 15 having a pair of substantially parallel blades.

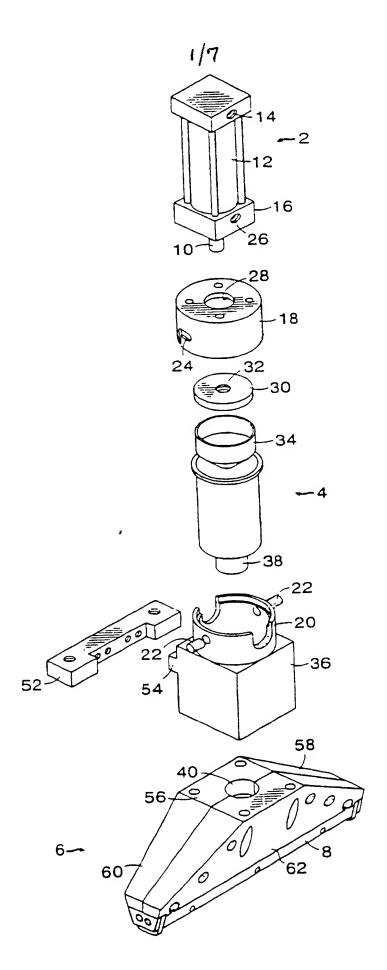


FIG. 1

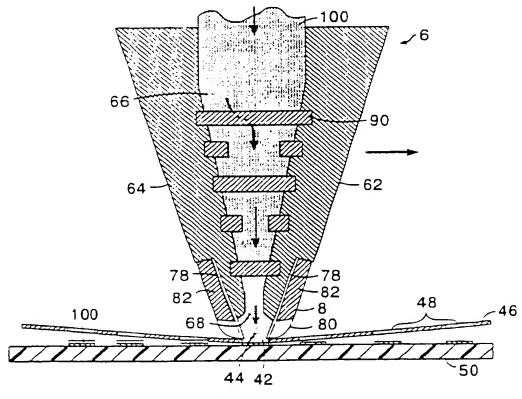
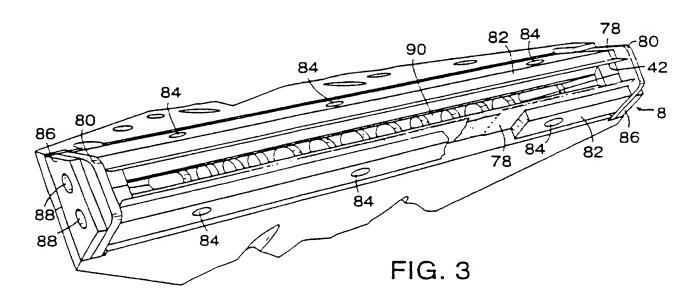
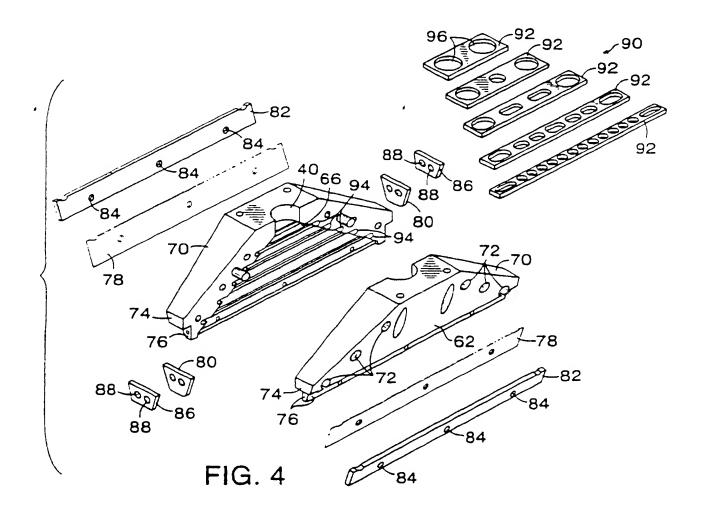


FIG. 2

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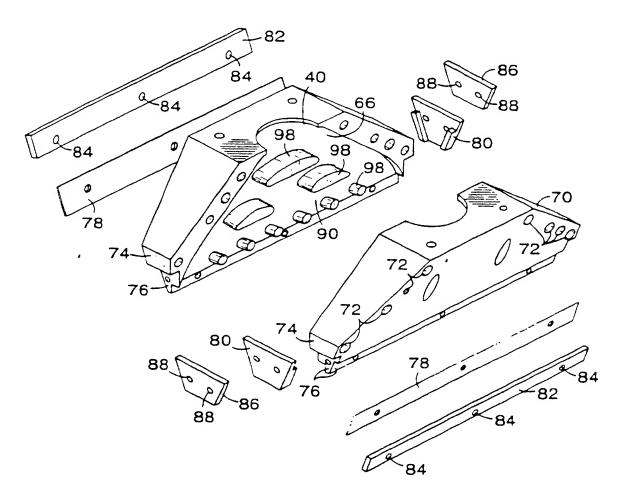
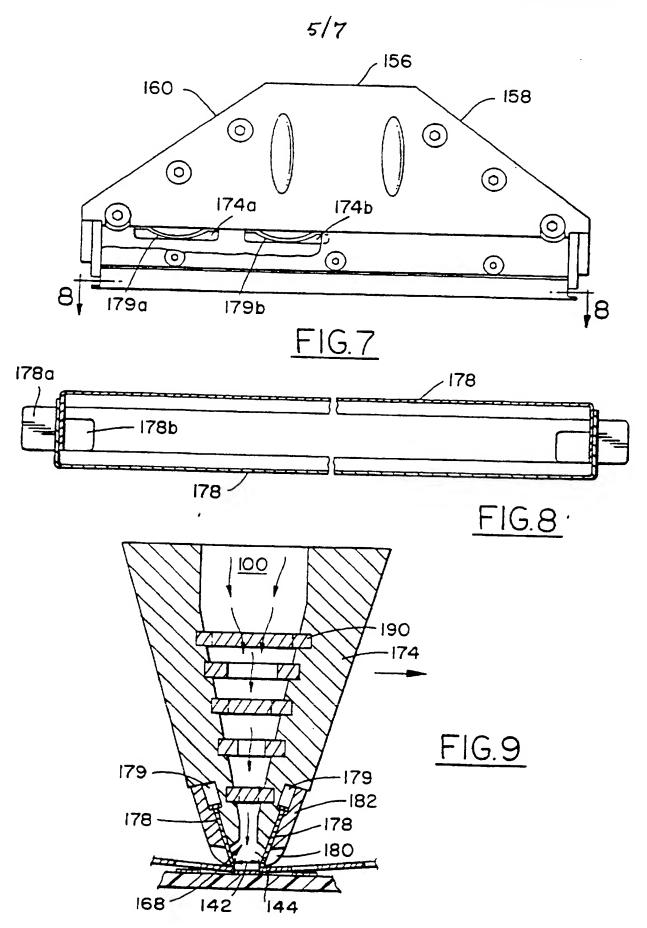
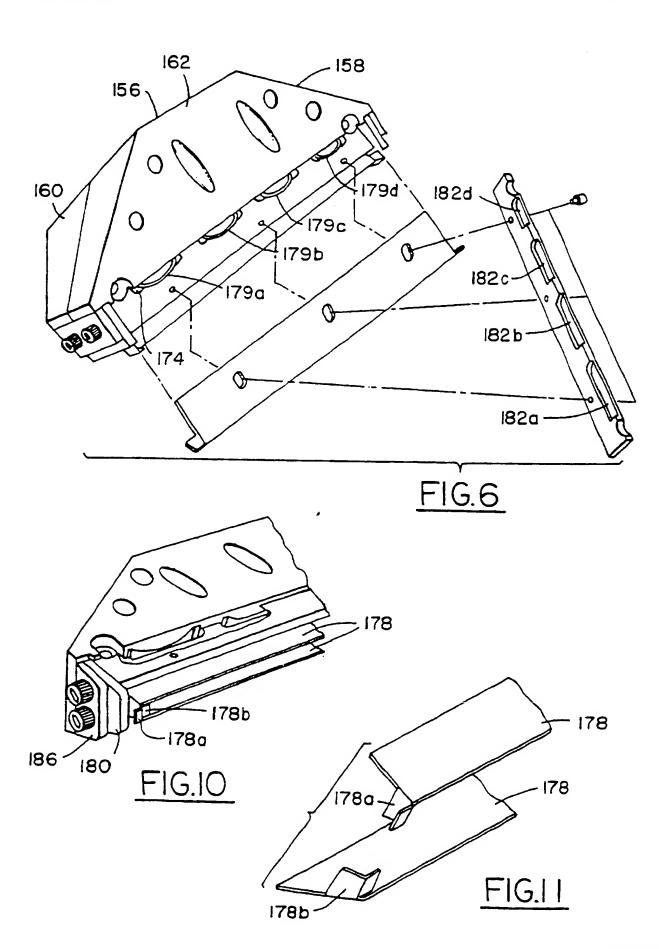
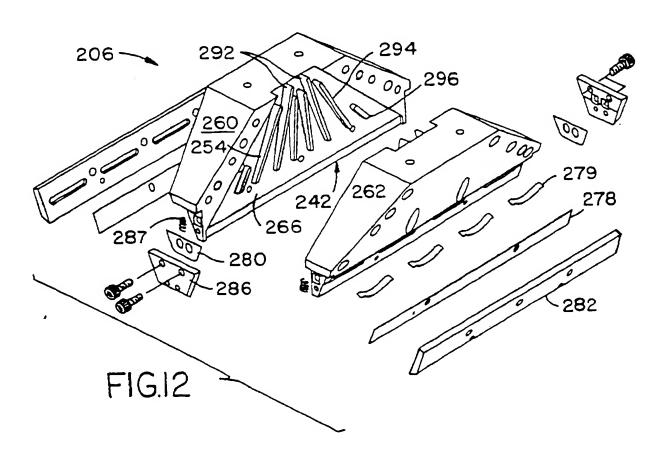


FIG. 5







INTERNATIONAL SEARCH REPORT

1. stional Application No

PUT 95/03002

A. CLASSIFICATION OF SUBJECT MATTER IPC 6 B41F15/42 H05K3/12

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols) IPC 6 B41F H05K H01L B23K

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

| Category * | Citation of document, with indication, where appropriate, of the relevant passages | Relevant to claim No. |
|------------|---|-----------------------|
| Υ | EP,A,0 504 501 (ZIMMER) 23 September 1992 | 1-4,6,8, |
| | see column 19, line 56 - column 21, line 16; figures 24,25 | |
| A | 10, 1, 91, 00 1, 10 | 10-13, 16,17 |
| Y | US,A,4 023 486 (LINTHICUM ET AL.) 17 May 1977 see the whole document | 1-4,6,8, |
| Α | PATENT ABSTRACTS OF JAPAN vol. 13 no. 434 (M-875) ,28 September 1989 & JP,A,01 166961 (MATSUSHITA ELECTRIC IND CO) 30 June 1989, see abstract | 1,6,8, 10,11,13 |
| | -/ | |

| * Special categories of cited documents: "A" document defining the general state of the art which is not considered to be of particular relevance. | "T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention | | | |
|---|---|--|--|--|
| "E" earlier document but published on or after the international filing date "L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified) "O" document referring to an oral disclosure, use, exhibition or other means "P" document published prior to the international filing date but later than the priority date claimed | "X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art. "&" document member of the same patent family | | | |
| Date of the actual completion of the international search 22 March 1996 | Date of mailing of the international search report 1 8, 04, 96 | | | |
| Name and mailing address of the ISA European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk Td. (+31-70) 340-2040, Tx. 31 651 epo nl, Fax: (+31-70) 340-3016 | Authorized officer Mes, L | | | |

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Further documents are listed in the continuation of box C.

Patent family members are listed in annex.

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